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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/534,962	05/16/2005	Masayoshi Kondo	033036.088	1696
25461 SMITH GAM	25461 7590 09/07/2007 SMITH, GAMBRELL & RUSSELL		EXAMINER	
SUITE 3100, PROMENADE II 1230 PEACHTREE STREET, N.E. ATLANTA, GA 30309-3592		•	PATEL, ISHWARBHAI B	
			ART UNIT .	PAPER NUMBER
,			2841	
			MAIL DATE	DELIVERY MODE
			09/07/2007	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)				
·	10/534,962	KONDO ET AL.				
Office Action Summary	Examiner	Art Unit				
·	Ishwar (I. B.) Patel	2841				
The MAILING DATE of this communication app						
Period for Reply		·				
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION (6(a). In no event, however, may a reply be time till apply and will expire SIX (6) MONTHS from cause the application to become ABANDONEI	I. lely filed the mailing date of this communication. 0 (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on <u>25 July 2007</u> .						
· <u> </u>	,—					
	3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under E	x parte Quayle, 1935 C.D. 11, 45	i3 O.G. 213.				
Disposition of Claims	•					
4)⊠ Claim(s) <u>1-32</u> is/are pending in the application.						
4a) Of the above claim(s) 1-16 and 21-32 is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.						
6) Claim(s) <u>17-20</u> is/are rejected.						
7) Claim(s) is/are objected to.	· alastias requirement	·				
8) Claim(s) are subject to restriction and/or election requirement.						
Application Papers .						
9) The specification is objected to by the Examiner	·.					
10)⊠ The drawing(s) filed on <u>16 May 2005</u> is/are: a)⊠ accepted or b)⊡ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).						
11) The oath or declaration is objected to by the Ex	aminer. Note the attached Office	Action or form PTO-152.				
Priority under 35 U.S.C. § 119						
12)⊠ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a)⊠ All b)□ Some * c)□ None of:						
1. Certified copies of the priority documents have been received.						
2. Certified copies of the priority documents have been received in Application No						
3. Copies of the certified copies of the priority documents have been received in this National Stage						
application from the International Bureau (PCT Rule 17.2(a)).						
* See the attached detailed Office action for a list of the certified copies not received.						
		•				
Attachment(s)						
1) Notice of References Cited (PTO-892) A) Interview Summary (PTO-413) Notice of Draftsperson's Patent Drawing Review (PTO-948) Paper No(s)/Mail Date						
3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date 5/16/05.	5) Notice of Informal Pa					

Application/Control Number: 10/534,962 Page 2

Art Unit: 2841

DETAILED ACTION

Election/Restrictions

1. Applicant's election of group I, sub-specie B2, claims 17-20 in the reply filed on July 25, 2007 is acknowledged. Because applicant did not distinctly and specifically point out the supposed errors in the restriction requirement, the election has been treated as an election without traverse (MPEP § 818.03(a)). Claims 1-16 and

Priority

Acknowledgment is made of applicant's claim for foreign priority under 35
 U.S.C. 119(a)-(d). The certified copy has been received and placed of record in the file.

Claim Objections

Claims 17-20 are objected to because of the following informalities:
 Regarding claim 17, "the multilayer portion," line 9, lacks antecedent basis.

 Claims 18-20 depend upon claim 17 and inherit the same deficiency.
 Appropriate correction is required.

Claim Rejections - 35 USC § 103

- 4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the

Art Unit: 2841

invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

5. Claims 17-19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Shimizu (US Patent No. 6,570,098) in view of Dixon (US Patent No. 4,800,461).

Regarding claim 17, Shimuzu in figure 13 discloses a multilayer wiring board comprising (i) plural single-sided wiring boards (3, 4, 5, 6, figure 2) having a wiring pattern formed on one side of a substrate made of an insulating material and two-layer conductor posts made of copper and a metal (shown in figure 4,copper with nickel plating), each said conductor post projecting from said wiring pattern to the side of said substrate opposite from said wiring pattern (see figure 2), with the substrates other than that of the outermost layer having, on the side opposite from said conductor posts, the pads for making connection to the conductor posts, and said wiring pattern having no surface coating (see figure), (ii) a wiring board (51) having on at least one side thereof the pads for connection to said conductor posts and comprising a wiring pattern (see figure 2, element 2 is equivalent to element 51 of figure 13)), and (iii) an adhesive layer (7) whereby the respective boards are laminated integrally, wherein said conductor posts and pads are connected by a metal or an alloy through the medium of said adhesive layer, and said wiring patterns are electrically connected (see figure 2 and 13).

Shimuzu does not disclose the wiring board as a flexible board, surface the coating applied on the flexible portion but no surface coating applied on the multilayer portion and the adhesive having flux function. Middle portion (51) of Simuzu is rigid.

However, the board with flexible middle portion with coating on the flexible portion for protection are old and known in the art facilitating the flexibility during operation.

Dixon in figure 3 discloses a circuit board with a flexible portion with an insulating coating (20) in the flexible portion.

Therefore, it would have been obvious to a person of ordinary skill in the art at the time of applicant's invention to provide the board of Shimuzu with the middle part (51) made of a flexible substrate with the coating on the flexible portion, as taught by Dixon, in order to have the flexibility during operation or mounting.

Regarding the limitation, the adhesive having flux function, it is old and known in the art to use adhesive with flux function for better connection strength. Pennisi discloses an adhesive (120) with fluxing function to promote adhesion (column 3, line 5-20).

Therefore, it would have been obvious to a person of ordinary skill in the art at the time of applicant's invention to provide the board of Shimuzu with the adhesive having the flux function, as taught by Pennisi, in order to have better connection strength.

Regarding claim 18, Shimuzu further discloses said flexible wiring board is a severed individual piece (as the board of Shimuzu is an individual piece).

Application/Control Number: 10/534,962 Page 5

Art Unit: 2841

Regarding claim 19, Shimuzu further discloses the metal is nickel (column 4, line 61).

6. Claim 20 is rejected under 35 U.S.C. 103(a) as being unpatentable over the modified board of Shimizu as applied to claim 17 above, and further in view of Nakamura (US Patent No. 6,395,993).

Regarding claim 20, Shimuzu discloses all the features of the claimed invention as applied to claim 17 above but does not disclose the alloy comprises at least two of tin, lead, silver, zinc, bismuth, antimony and copper. Shimuzu discloses a metal, nickel with gold. However, use of alloy on the bump is old and known in the art for getting desired bonding strength. Nakamura discloses a board with a solder coating made of tin/zink (36) on the bump (figure 30) and further recites that low melting metals such as copper, nickel, copper-nickel alloys and alloy based on tin and gold may also be used.

Therefore, it would have been obvious to a person of ordinary skill in the art at the time of applicant's invention to provide the modified board of Shimuzu with the alloy comprises at least two of tin, lead, silver, zinc, bismuth, antimony and copper, as taught by Nakamura, in order to have desired bonding properties.

Conclusion

7. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Application/Control Number: 10/534,962 Page 6

Art Unit: 2841

J. M. Shaheen (US Patent No. 3,471,348) discloses a multilayer board with flexible portion.

Enomoto (US Patent No. 6,586,686) in figure 1 discloses a multilayer board with bump (38c,d) made up of solder or indium alloy (column 6, line 12).

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Ishwar (I. B.) Patel whose telephone number is (571) 272 1933. The examiner can normally be reached on M-F (8:30 - 5:00).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Dean Reichard can be reached on (571) 272 1984. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Ishwar (I. B.) Patel Primary Examiner

Art Unit: 2841

ibp September 3, 2007